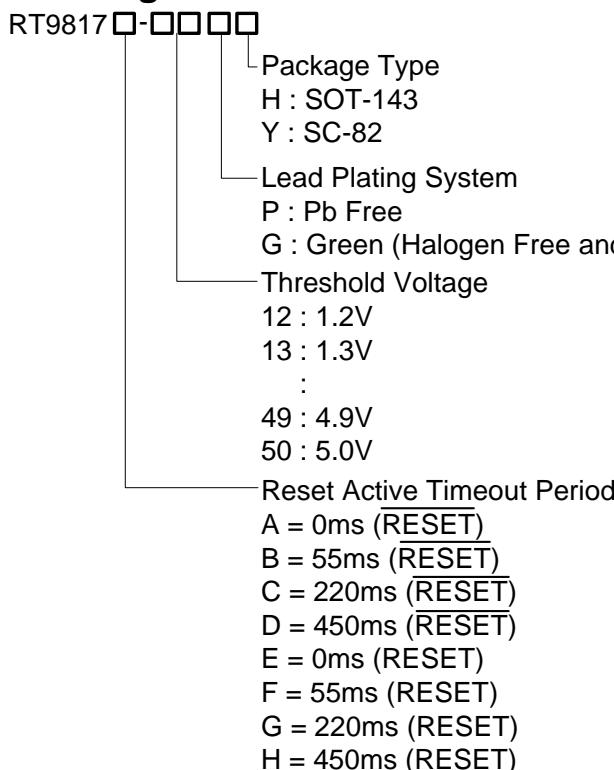


Micro-Power Voltage Detectors with Manual Reset

General Description

The RT9817 is a micro-power voltage detector with deglitched manual reset input supervising the power supply voltage level for microprocessors (μ P) or digital systems. It provides internally fixed threshold levels with 0.1V per step ranging from 1.2V to 5V, which covers most digital applications. It features low supply current of 3 μ A. The RT9817 performs supervisory function by sending out a reset signal whenever the V_{DD} voltage falls below a preset threshold level. This reset signal will last the whole period before V_{DD} recovering. Once V_{DD} recovered upcrossing the threshold level, the reset signal will be released after a certain delay time. To pull reset signal low manually, just pull the manual reset input (MR) below the specified V_{IL} level. RT9817 is provided in SC-82 and SOT-143 packages.

Ordering Information



Note :

Richtek products are :

- RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- Suitable for use in SnPb or Pb-free soldering processes.

Features

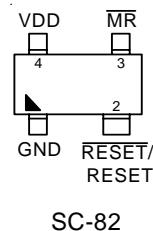
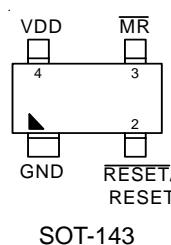
- Internally Fixed Threshold 1.2V to 5V in 0.1V Step
- High Accuracy $\pm 1.5\%$
- Low Supply Current 3 μ A
- No External Components Required
- Quick Reset within 20 μ s
- Built-in Recovery Delay Include 0ms, 55ms, 220ms, 450ms Options
- 800ns Glitch Immunity of Manual Reset Input
- Low Functional Supply Voltage 0.9V
- CMOS Push-Pull Output
- Small SC-82 and SOT-143 Packages
- RoHS Compliant and 100% Lead (Pb)-Free

Applications

- Computers
- Controllers
- Intelligent Instruments
- Critical μ P and μ C Power Monitoring
- Portable/Battery-Powered Equipment

Pin Configurations

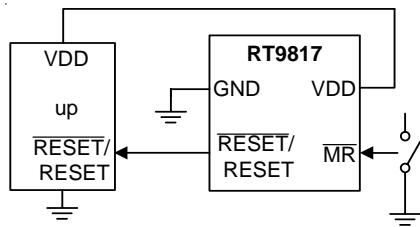
(TOP VIEW)



Marking Information

For marking information, contact our sales representative directly or through a RichTek distributor located in your area, otherwise visit our website for detail.

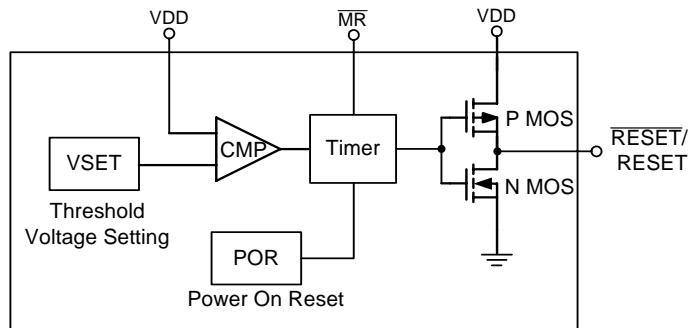
Typical Application Circuit



Functional Pin Description

Pin Name	Pin Function
GND	Ground Pin
RESET	Active Low Push-Pull Reset Output
RESET	Active High Push-Pull Reset Output
MR	Manual Reset
VDD	Power Pin

Function Block Diagram



Absolute Maximum Ratings (Note 1)

- Terminal Voltage (with Respect to GND)

V_{DD}	-----	-0.3V to 6.0V
----------	-------	---------------
- All Other Inputs ----- -0.3V to $V_{DD}+0.3V$
- Input Current, I_{VDD} ----- 20mA
- Power Dissipation, PD @ $T_A = 25^\circ C$

SC-82	-----	0.25W
SOT-143	-----	0.285W
- Package Thermal Resistance (Note 2)

SC-82, θ_{JA}	-----	400°C
SOT-143, θ_{JA}	-----	350°C
- Lead Temperature (Soldering, 10sec.) ----- 260°C
- Storage Temperature Range ----- -65°C to 125°C
- ESD Susceptibility (Note 3)

HBM (Human Body Mode)	-----	2kV
MM (Machine Mode)	-----	200V

Recommended Operating Conditions (Note 4)

- Junction Temperature Range ----- -40°C to 125°C
- Ambient Temperature Range ----- -40°C to 85°C

Electrical Characteristics

($V_{DD} = 3V$, $T_A = 25^\circ C$, unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Operating V_{DD} (V_{OUT}) Range	V_{DD}	RT9817A/B/C/D	0.9	--	6	V
		RT9817E/F/G/H	1.1	--	6	
Supply Current	I_{DD}	$V_{TH} = 3V$, $V_{DD} = 4.5V$	--	3	8	μA
Reset Threshold	V_{TH}		--	1.2 to 5.0	--	V
Threshold Voltage Accuracy	ΔV_{TH}		-1.5	--	+1.5	%
Threshold Voltage Hysteresis	V_{HYS}		--	0.01 V_{TH}	--	V
V_{DD} Drop to Reset Delay	t_{RD}	Drop = $V_{TH} - 125mV$	--	20	--	μs
Reset Active Time Out Period	RT9817A/E	$V_{DD} \geq 1.02 \times V_{TH}$	--	0	--	ms
	RT9817B/F		35	55	75	ms
	RT9817C/G		143	220	297	ms
	RT9817D/H		292	450	608	ms
RESET Output Voltage Low	V_{OL}	$V_{DD} < V_{TH(MIN)}$, $I_{SINK} = 3.5mA$, $V_{TH} \geq 3V$	--	--	0.4	V
		$V_{DD} < V_{TH(MIN)}$, $I_{SINK} = 1.2mA$, $V_{TH} \geq 1.8V$	--	--	0.3	
		$V_{TH(MIN)} > V_{DD} > 1V$, $I_{SINK} = 0.5mA$	--	--	0.3	

To be continued

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
RESET Output Voltage High	V_{OH}	$V_{DD} > V_{TH(MAX)}$, $I_{SOURCE} = 800\mu A$, $V_{TH} \geq 3V$	$V_{DD} - 1.5$	--	--	V
		$V_{DD} > V_{TH(MAX)}$, $I_{SOURCE} = 500\mu A$, $V_{TH} \geq 1.8V$	0.8 V_{DD}	--	--	
		$V_{DD} > V_{TH(MAX)}$, $I_{SOURCE} = 200\mu A$, $V_{TH} \geq 1.1V$	0.8 V_{DD}	--	--	
RESET Output Voltage Low	V_{OL}	$V_{DD} > V_{TH(MAX)}$, $I_{SINK} = 3.5mA$, $V_{TH} \geq 3V$	--	--	0.4	V
		$V_{DD} > V_{TH(MAX)}$, $I_{SINK} = 1.2mA$, $V_{TH} \geq 1.8V$	--	--	0.3	
		$V_{DD} > V_{TH(MAX)}$, $I_{SINK} = 0.5mA$, $V_{TH} \geq 1.2V$	--	--	0.3	
RESET Output Voltage High	V_{OH}	$1.1V < V_{DD} < V_{TH(MIN)}$, $I_{SOURCE} = 200\mu A$	0.8 V_{DD}	--	--	V
		$1.8V < V_{DD} < V_{TH(MIN)}$, $I_{SOURCE} = 500\mu A$	0.8 V_{DD}	--	--	
		$3V < V_{DD} < V_{TH(MIN)}$, $I_{SOURCE} = 800\mu A$	$V_{DD} - 1.5$	--	--	

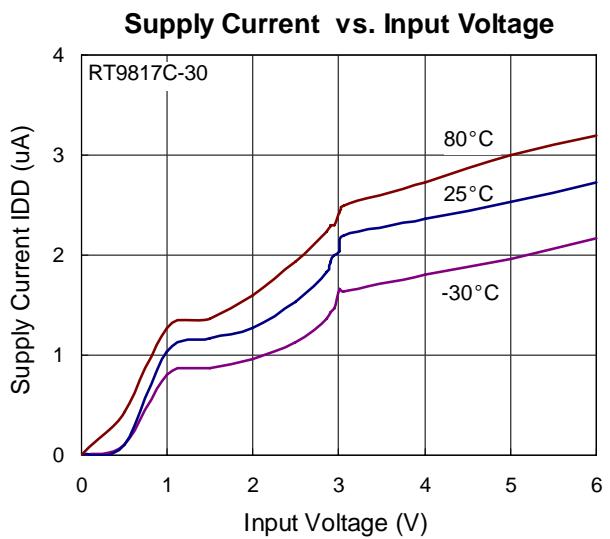
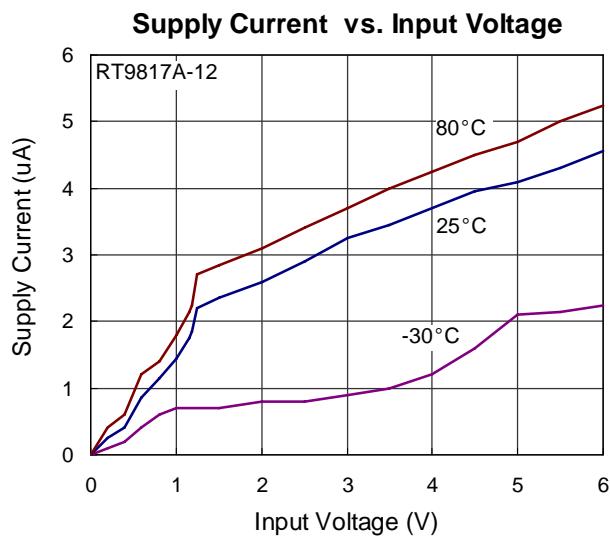
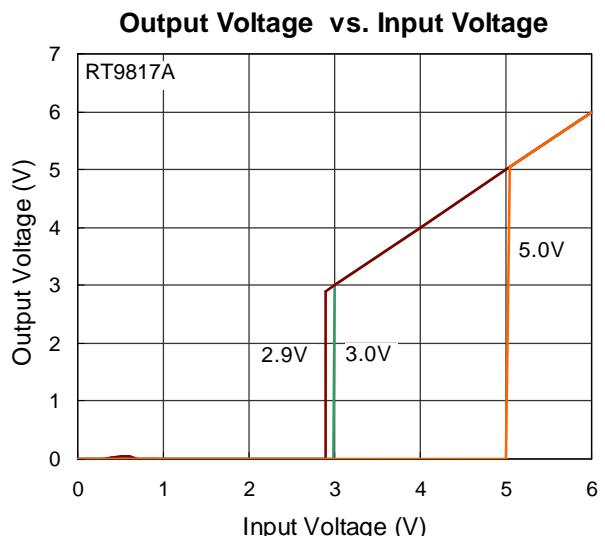
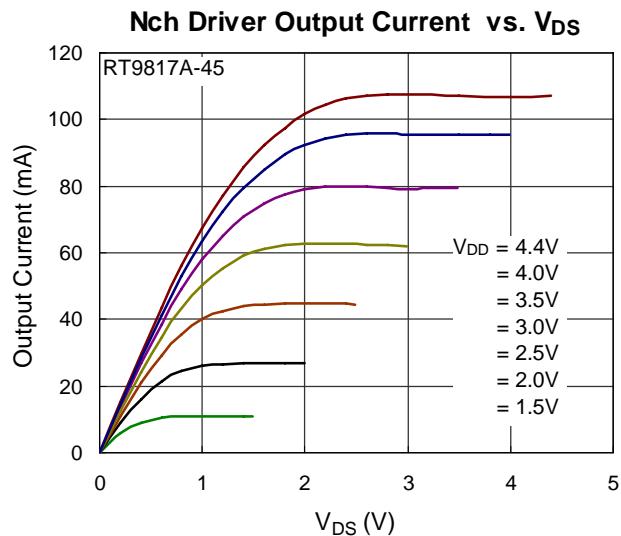
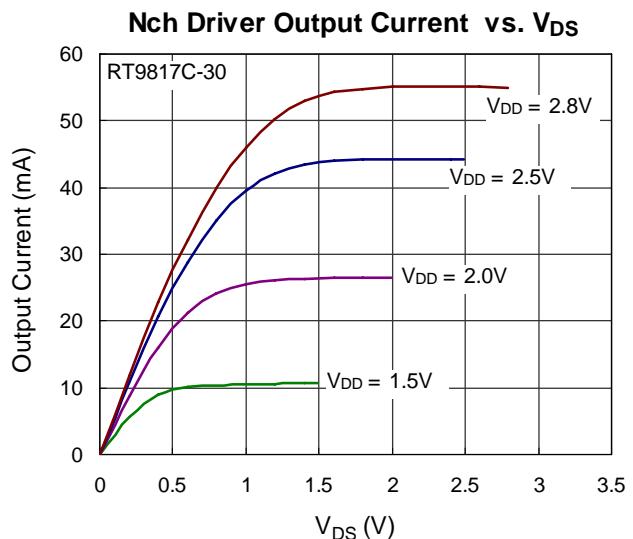
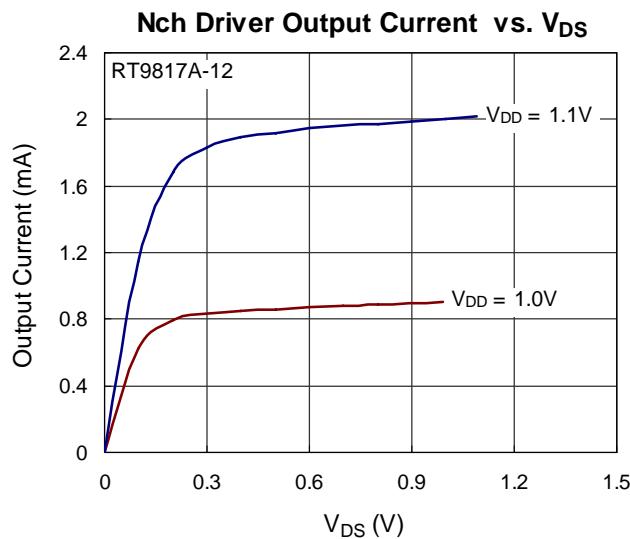
Note 1. Stresses listed as the above "Absolute Maximum Ratings" may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may remain possibility to affect device reliability.

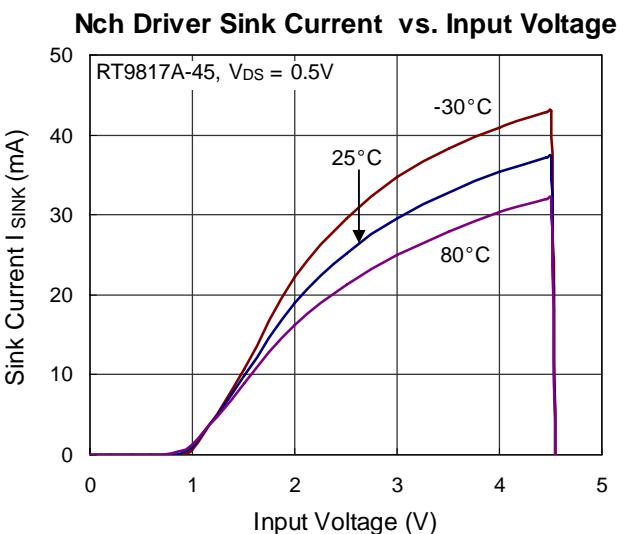
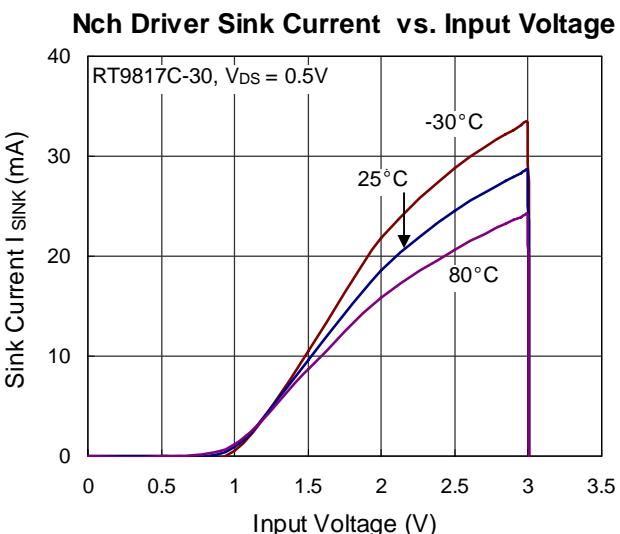
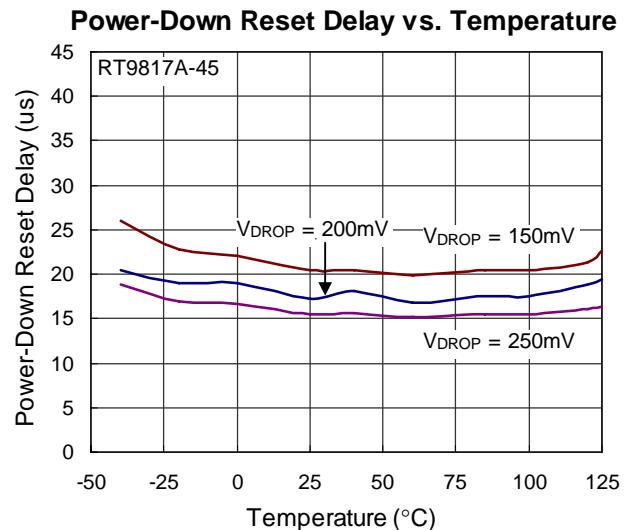
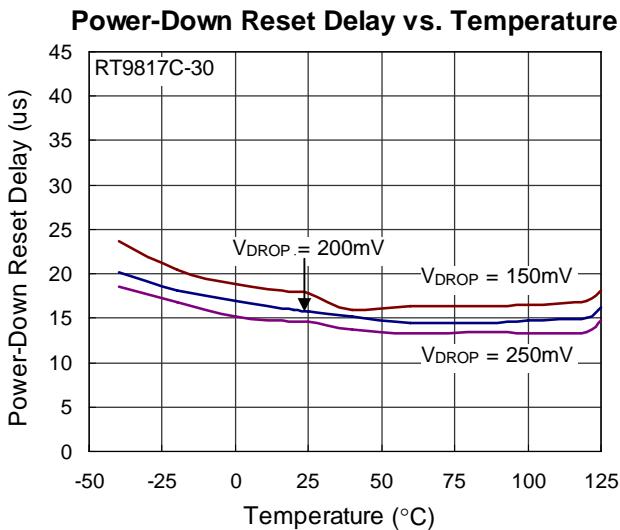
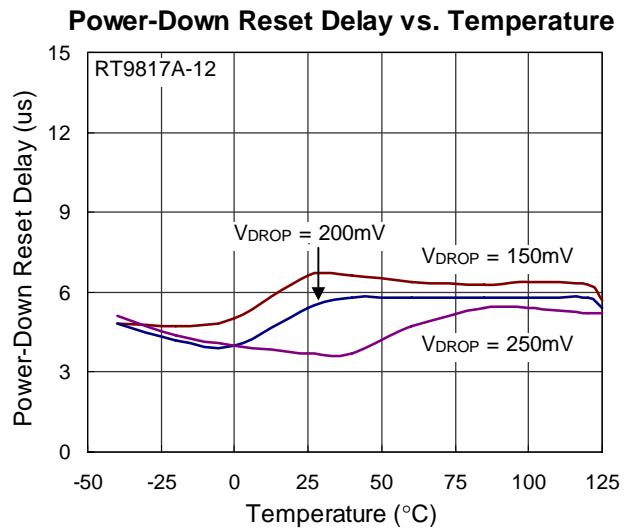
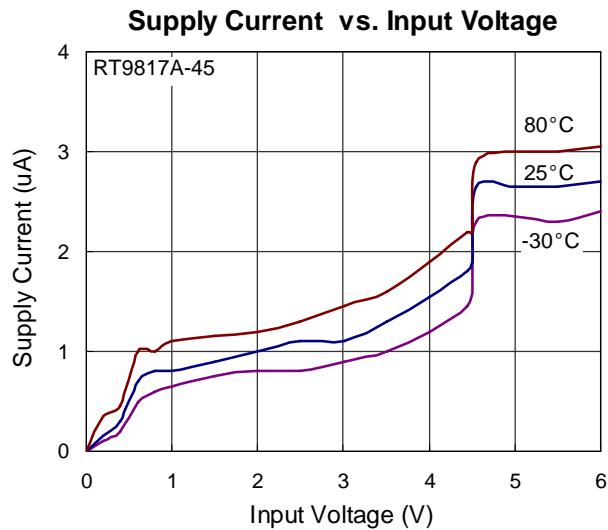
Note 2. θ_{JA} is measured in the natural convection at $T_A = 25^\circ C$ on a low effective thermal conductivity test board of JEDEC 51-3 thermal measurement standard.

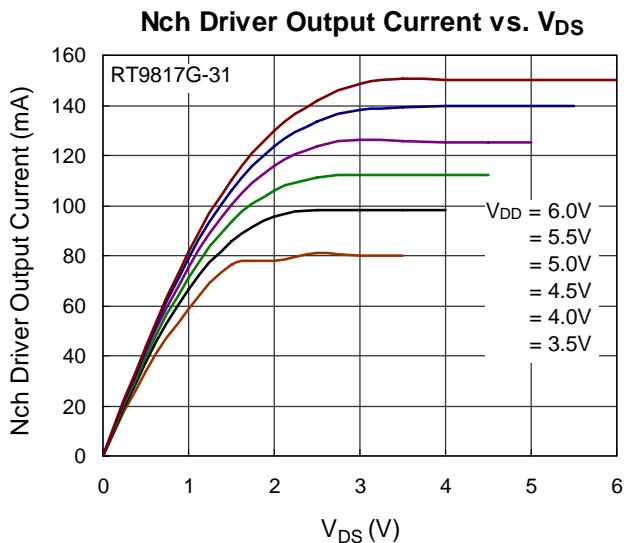
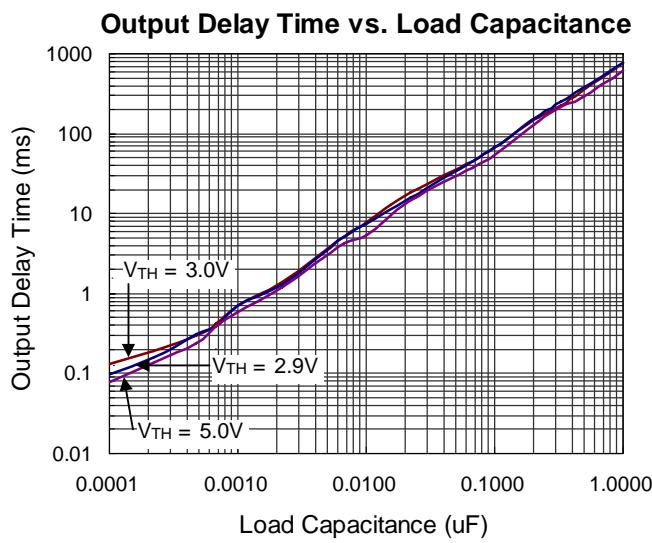
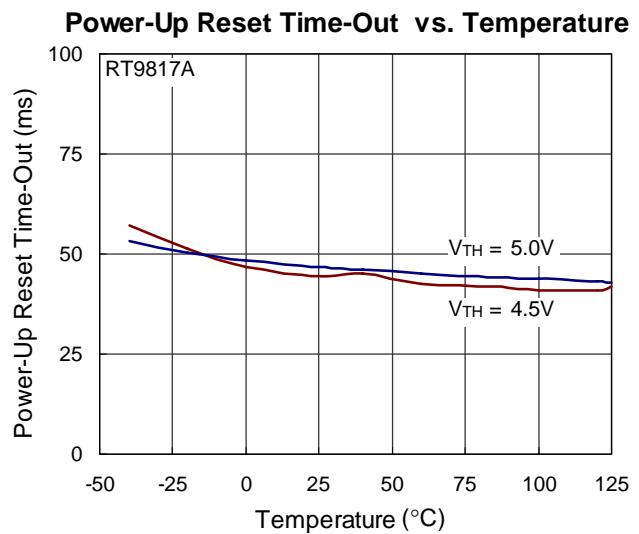
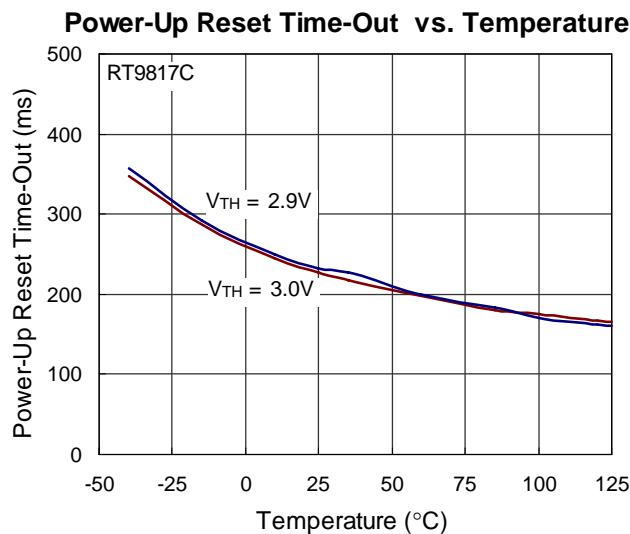
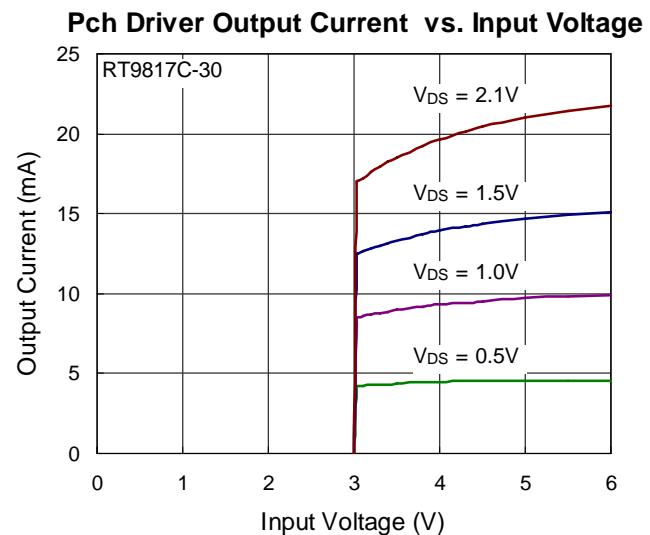
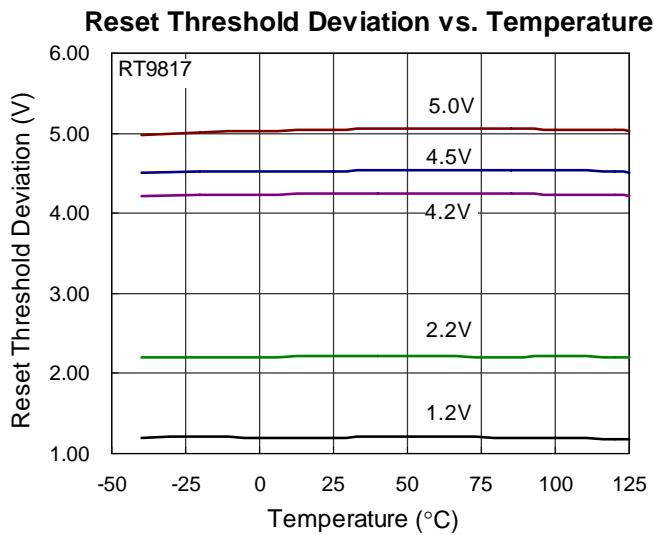
Note 3. Devices are ESD sensitive. Handling precaution is recommended.

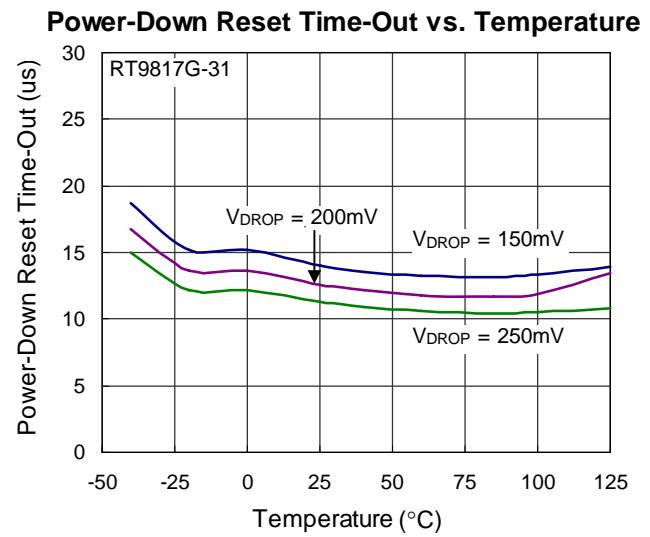
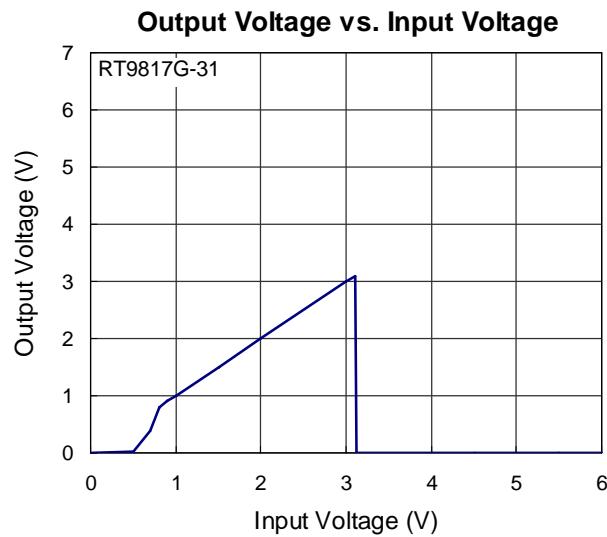
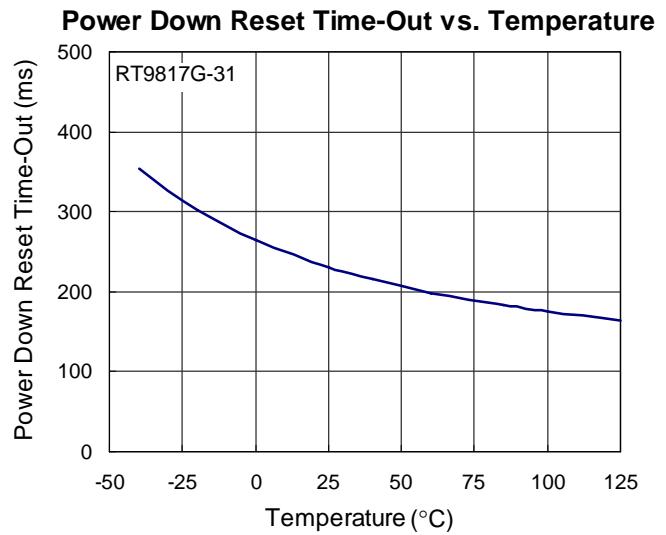
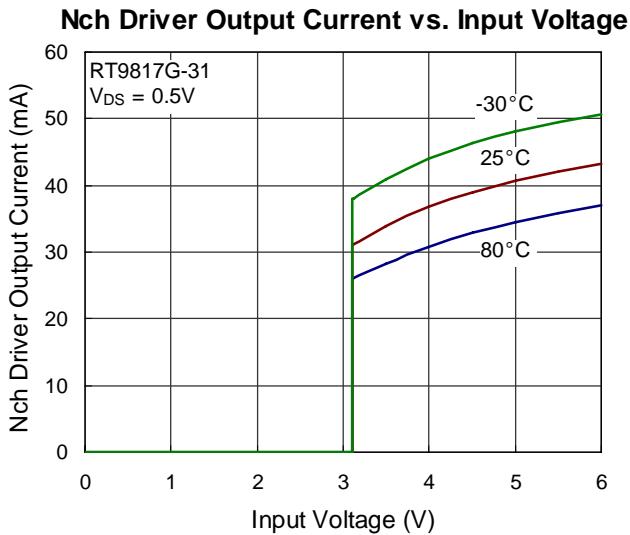
Note 4. The device is not guaranteed to function outside its operating conditions.

Typical Operating Characteristics







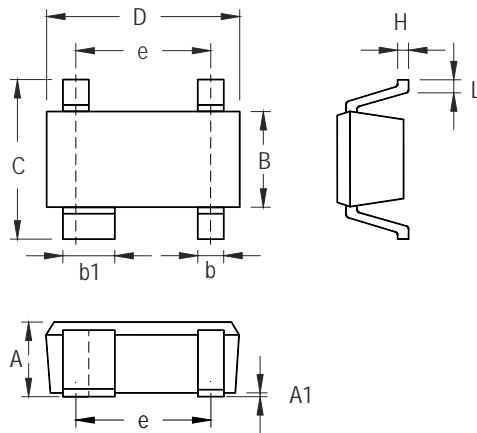


Application Information

Benefits of Highly Accurate Reset Threshold

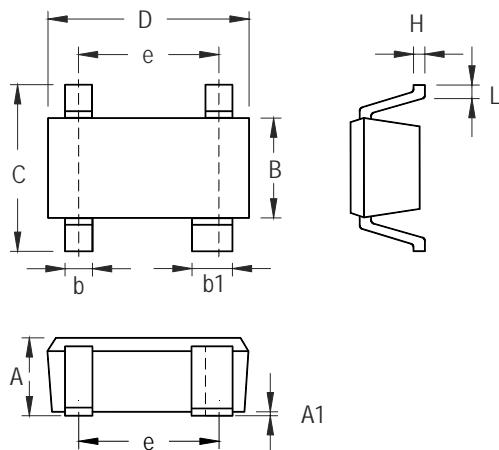
Most µP supervisor ICs have reset threshold voltages between 1% and 1.5% below the value of nominal supply voltages. This ensures a reset will not occur within 1% of the nominal supply, but will occur when the supply is 1.5% below nominal.

Outline Dimension



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.800	1.200	0.031	0.047
A1	0.050	0.150	0.002	0.006
B	1.200	1.400	0.047	0.055
b	0.300	0.520	0.012	0.020
b1	0.760	0.920	0.030	0.036
C	2.100	2.640	0.083	0.104
D	2.800	3.040	0.110	0.120
e	1.900		0.075	
H	0.080	0.150	0.003	0.006
L	0.210	0.410	0.008	0.016

SOT-143 Surface Mount Package



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.800	1.100	0.031	0.043
A1	0.000	0.100	0.000	0.004
B	1.150	1.350	0.045	0.053
b	0.150	0.400	0.006	0.016
b1	0.350	0.500	0.014	0.020
C	1.800	2.450	0.071	0.096
D	1.800	2.200	0.071	0.087
e	1.300		0.051	
H	0.080	0.260	0.003	0.010
L	0.200	0.460	0.008	0.018

SC-82 Surface Mount Package

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